



80V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D Tc = +25°C
901/	7.8mΩ @ V _G S = 10V	83A
80V	11mΩ @ V _{GS} = 4.5V	70A

Description and Applications

This new generation MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in power management and load switches.

- DC-DC converters
- Load switches

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low Rds(ON) Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

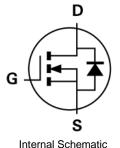
 https://www.diodes.com/quality/product-definitions/

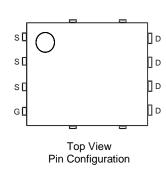
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 <a>(3)
- Weight: 0.097 grams (Approximate)

Site 1:





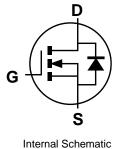


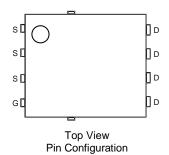
Site 2:

PowerDI5060-8/SWP (Type UX)



Bottom View





Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Top View



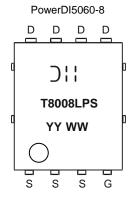
Ordering Information (Note 4)

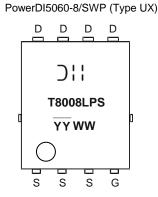
Part Number	Package	Packing		
Fait Number	Fackage	Qty.	Carrier	
DMT8008LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DIWI16006LF3-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





⊃¦¦ = Manufacturer's Marking T8008LPS = Product Type Marking Code YYWW or YYWW = Date Code Marking YY or YY = Year (ex: 23 = 2023) WW = Week (01 to 53)

Maximum Ratings (@Tc = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	80	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 5)	I _D	83 66	А		
Maximum Continuous Body Diode Forward Current (Note 5)			Is	69	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	330	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			Іѕм	330	А
Avalanche Current, L = 0.1mH (Note 6)			las	23	Α
Avalanche Energy, L = 0.1mH (Note 6)			Eas	26.5	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	T _A = +25°C	P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	99	°C/W
Total Power Dissipation (Note 8)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R _{0JA}	45	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	83	W
Thermal Resistance, Junction to Case (Note 5)		R _θ JC	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

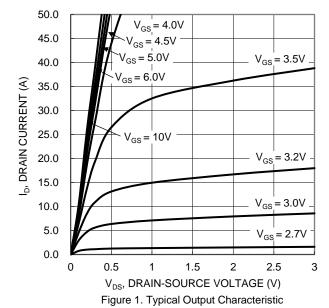
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	80	_	_	V	VGS = 0V, ID = 1mA
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	Vgs(TH)	1.3	_	2.8	V	V _{DS} = V _{GS} , I _D = 1mA
Static Drain-Source On-Resistance	D	_	5	7.8	mΩ	$V_{GS} = 10V, I_D = 14A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	8	11	11122	$V_{GS} = 4.5V, I_D = 12A$
Diode Forward Voltage	VsD	_	0.8	1.2	V	VGS = 0V, IS = 14A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	2345	_		V _{DS} = 40V, V _{GS} = 0V f = 1MHz
Output Capacitance	Coss	_	842	_	pF	
Reverse Transfer Capacitance	Crss	_	51.9	_		
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	21.7	_		
Total Gate Charge (V _{GS} = 10V)	Qg	_	41.2	_	nC	V _{DD} = 40V, I _D = 2A
Gate-Source Charge	Qgs	_	5.0	_	nc	
Gate-Drain Charge	Q_{gd}	_	10.6	_		
Turn-On Delay Time	tD(ON)	_	5.8	_		
Turn-On Rise Time	t _R	_	5.4	_		$V_{DD} = 40V, V_{GS} = 10V$ $I_D = 2A, R_g = 1.6\Omega$
Turn-Off Delay Time	tD(OFF)	_	24.5	_	ns	
Turn-Off Fall Time	t _F	_	43.2	_		
Body Diode Reverse Recovery Time	t _{RR}	_	61	_	ns	I 20 dl/dt 4000/cc
Body Diode Reverse Recovery Charge	Qrr	_	181	_	nC	I _F = 2A, dI/dt = 100A/μs

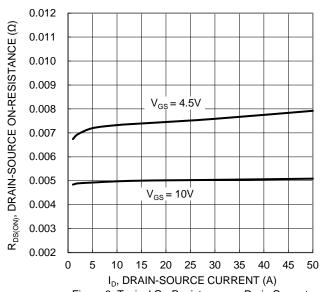
Notes:

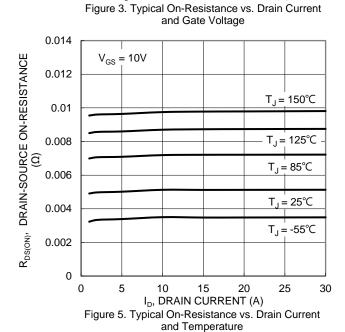
^{9.} Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

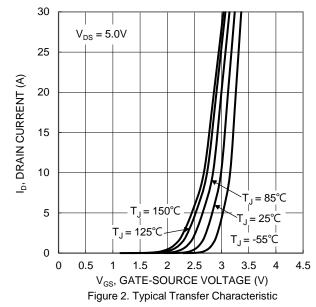
DMT8008LPS

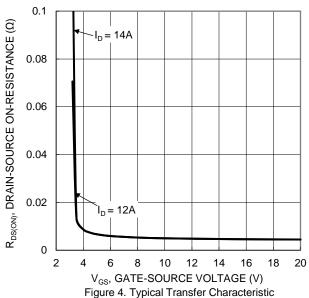












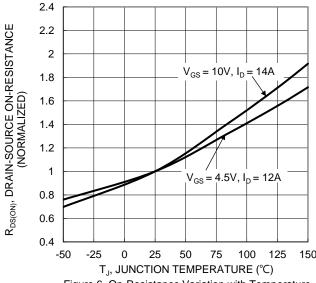


Figure 6. On-Resistance Variation with Temperature

DMT8008LPS

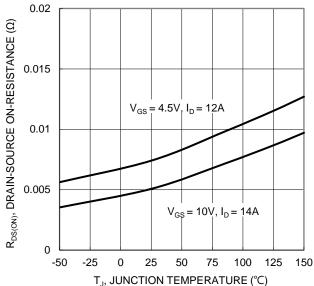
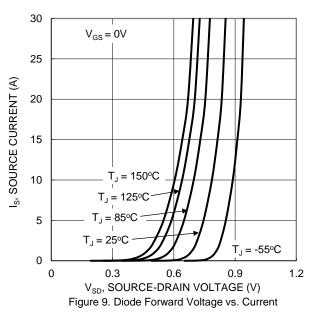


Figure 7. On-Resistance Variation with Temperature



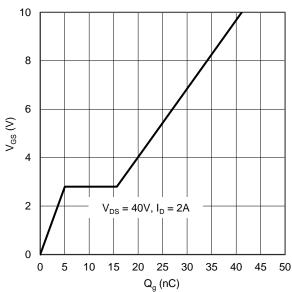
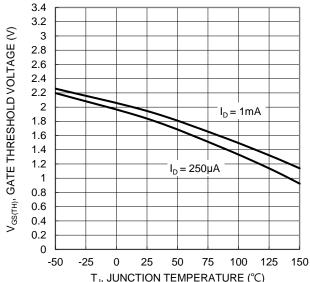
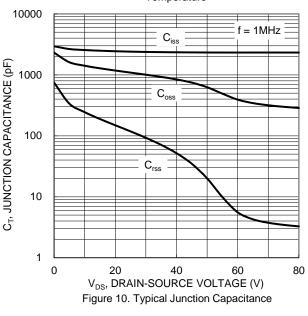


Figure 11. Gate Charge



 $\rm T_{J},\,JUNCTION\,TEMPERATURE\,(^{\circ}C)$ Figure 8. Gate Threshold Variation vs. Junction Temperature



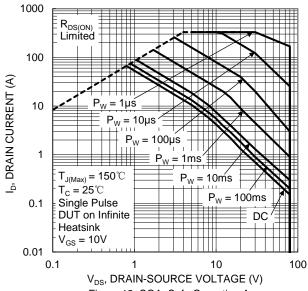


Figure 12. SOA, Safe Operation Area 5 of 9

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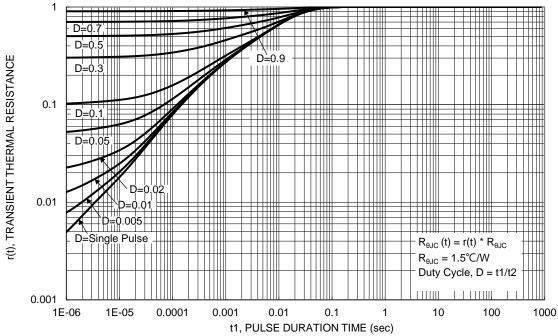


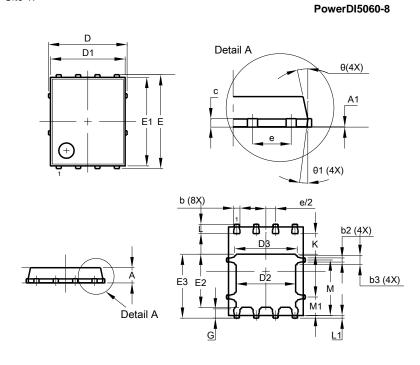
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

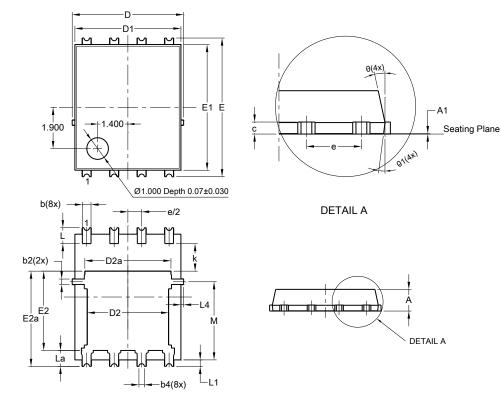
Site 1:



PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	ŧ,	5.15 BSC	,		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	•	1.27 BSC	,		
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D		.15 BS(
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0)	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BS0	;	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

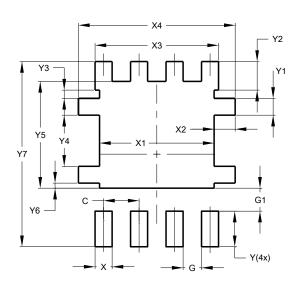


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

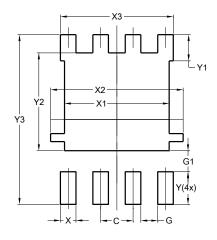
PowerDI5060-8



Dimensions	Value (in mm)
C	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
Difficusions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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